



**International  
Standard**

**ISO 9621**

**Space systems — Methods to decide  
thermal vacuum test cycles of  
recurring production according  
to precipitation efficiency and  
reliability**

*Systèmes spatiaux — Méthodes pour déterminer les cycles  
d'essais sous vide thermique de la production récurrente en  
fonction de l'efficacité et de la fiabilité des précipitations*

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## Foreword

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The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular, the different approval criteria needed for the different types of ISO document should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see [www.iso.org/directives](http://www.iso.org/directives)).

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This document was prepared by Technical Committee ISO/TC 20, *Aircraft and space vehicles*, Subcommittee SC 14, *Space systems and operations*.

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## Introduction

The thermal vacuum test is one of the most important and expensive environment tests of space systems. The thermal vacuum test is required in general to demonstrate the ability of the test item to meet the design, function and performance requirements under the combination of vacuum conditions and temperature extremes experienced during spaceflight, and to screen out initial failure, known as infant mortality, such as workmanship error, integration error and latent material defect (ISO 15864). The number of thermal cycles, to be referred hence forth as simply cycles, is one of the test conditions in thermal vacuum test, is an essential parameter used to determine the screening effectiveness of initial failure. The number of cycles should be determined, generally based on technical aspects and with careful consideration of various factors such as test item complexity, heritage, and maturity of design and manufacturing, as well as reliability required of the test article. However as experienced in mass production industry, it is a natural expectation that as the design and manufacturing process of an item matures through continuous improvement of the manufacturing process, workmanship defects and initial failure will be reduced.

This document provides two technical methods specified to calculate the precipitation efficiency and reliability by the failure data to measure the quantity of screening effectiveness used to determine number of cycles of thermal vacuum test. These methods can be applied to reduce the number of cycles performed during a thermal vacuum test specified for recurring production of flight hardware, such as higher volume unit production runs and hardware produced for large constellation programs. This document supplements ISO 15864 used as either an option to reduce or a tailoring method to the baseline of thermal vacuum and thermal cycle acceptance tests specific for the recurring production hardware.

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# Space systems — Methods to decide thermal vacuum test cycles of recurring production according to precipitation efficiency and reliability

## 1 Scope

This document provides technical methods to calculate the precipitation efficiency and liability of a flight model by measuring the screening effectiveness of thermal cycles. This document is applicable to the recurring production unit and other hardware assembly levels, as either an option to reduce or a method to tailor the baseline number of cycles for thermal vacuum and thermal cycle acceptance tests.

## 2 Normative references

The following documents are referred to in the text in such a way that some or all content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO 15864, *Space systems — General test methods for spacecraft, subsystems and units*

## 3 Terms, definitions, and abbreviated terms

### 3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in ISO 15864 and the following apply.

ISO and IEC maintain terminology databases for use in standardization at the following addresses:

- ISO Online browsing platform: available at <https://www.iso.org/obp>
- IEC Electropedia: available at <https://www.electropedia.org/>

#### 3.1.1

##### **failure**

termination of the ability of an *item* (3.1.5) to perform a required function

[SOURCE: ISO 10795:2019, 3.98]

#### 3.1.2

##### **flight model**

model dedicated to being launched and operated in orbit and subjected to acceptance testing

#### 3.1.3

##### **hardware**

*items* (3.1.5) of identifiable equipment including piece parts, components, assemblies, subsystems and systems

[SOURCE: ISO 10795:2019, 3.119, modified — The abbreviated term "H/W" has been removed.]

#### 3.1.4

##### **initial failure**

probability of *failure* (3.1.1) or defect under an environmental test

**3.1.5**

**item**

node of a product breakdown structure

Note 1 to entry: An item can be any functional unit, subsystem, or system in ISO 15864 that can be individually considered.

Note 2 to entry: An item can be considered either as a “product” or a “component” on a “product breakdown structure” of more than two levels of decomposition. Items are designated “products” when described as being decomposed and designated “components” when described as decompositions.

[SOURCE: ISO 10795:2019, 3.134, modified — The domain "<space system>" has been removed; in note 1 to entry, a reference has been made to ISO 15864.]

**3.1.6**

**latent defect**

defect caused by workmanship error, integration error or latent material, which is not detectable in a stress-free environment, but is either screened under environmental test conditions or flight environment

**3.1.7**

**precipitation efficiency**

**PE**

probability of screening out *latent defects* (3.1.6) in a specific environmental test

**3.1.8**

**reliability**

ability of an *item* (3.1.5) to perform as required under given conditions for a given time interval

Note 1 to entry: In this document, reliability is equivalent to the probability that the *hardware* (3.1.3) is failure-free.

[SOURCE: ISO 10795:2019, 3.198, modified — "a required function" has been replaced by "as required"; the original two notes to entry have been replaced by a new one.]

**3.1.9**

**tailoring**

process by which individual requirements of specifications, standards, and related documents are evaluated and made applicable to a specific project by selection and, in some exceptional cases, modification of existing or addition of new requirements

[SOURCE: ISO 10795:2019, 3.237]

**3.1.10**

**test temperature range**

difference between the maximum and minimum temperatures in a thermal vacuum test

Note 1 to entry: The thermal vacuum test is specified in ISO 15864:2021, 7.18.

**3.2 Abbreviated terms**

AT	acceptance test
MPE	maximum predicted environment
PE	precipitation efficiency
TCT	thermal cycle test
TESS	thermal environmental stress screening
TTC	telemetry, tracking and command
TVT	thermal vacuum test



## 4 Methods of TVT cycles determination

### 4.1 General

Thermal cycle and thermal vacuum tests (TVT) are required for system and certain types of subsystem/unit acceptance test (AT), as specified in ISO 15864:2021, Table 1 and Table 3. The number of cycles is determined in general by consideration of the overall development and test history of the hardware under test, for example, the complexity and heritage of design and tests of lower-level assemblies before integrated assemblies, TVT conditions such as temperature range and duration. Initial screening for latent defects of flight hardware, also called infant mortality, which is caused by manufacturing, material and workmanship defects, shall be demonstrated by the acceptance test. The determination of TVT cycles depends on the essential parameter used to measure the screening effectiveness for initial latent defects by the precipitation efficiency and reliability of the test. Although in ISO 15864 there is no statement for the value of number of cycles, the expected number of cycles for thermal environmental stress screening (TESS) is determined by the required precipitation efficiency (PE) and temperature range in TVT<sup>[1],[2]</sup>.

The number of TVT cycles for the relevant kinds of hardware (system, subsystem and unit) of recurring production can be tailored to reduce the number of cycles specified in baseline requirement by prior experience and studies of the failure database. This document provides the technical methods to support tailoring thermal vacuum test cycles of the relevant hardware. Methods used to calculate the precipitation efficiency and reliability are used to measure the quantity of the TESS effectiveness, by the priorly revealed failure database collected from the objective hardware. The failure database used in these methods shall support the justification of number of cycles determination.

The term of recurring production stated herein shall be replaced by spacecraft, subsystem or unit defined in ISO 15864 in case of tailoring the baseline of thermal vacuum and thermal cycle acceptance tests. Recurring production can be hardware used for constellation programs, or more generally, the hardware made with a constant block of design and manufacture, such as mass production hardware, replicating manufactured hardware.

The failure database may be extended to the hardware that has similarity in design, manufacture and part grade integrated in the production, but the technical rationale of supporting the similarity claim shall be justified. An example to support similarity can be when the hardware is designed and manufactured by relative standards, reliability and quality control by same management standards, high class parts (e.g. class I) are used in the hardware<sup>[3]</sup>.

### 4.2 Failure data collection and analysis

The failure distribution function is used for estimating TESS effectiveness by the fatigue induced stress. Failure data collected shall be revealed that failures are relevant to initial defects due to foreign substance contamination in manufacturing and workmanship of the relevant hardware. Failure data collection at acceptance TVT shall provide the following basic information.

- a) The cycle numbers and test parameters, including minimum and maximum temperatures, in the TVT when the failure occurred. The minimum temperature of failure data collected should be 55 °C.
- b) The results from function tests performed. A function test shall be performed during and after exposure to the TVT environment to ensure the perceptiveness of potential failures. In cases that failures are discovered after exposing to TVT environment and the cycles when the failure occurred are difficult to be identified, an increased number of cycles should be assigned. This assignment of increased cycles is to obtain a conservative estimation.
- c) Failure data from previous and/or follow-on environmental tests. If the hardware is exposed to a number of environments sequential, for example, a vibration environment could be exposed on the hardware before or after TVT, the failure data collected shall be carefully analysed. Failures escaping from a previous exposure environment or into a follow-on exposed environment shall be carefully analysed to confirm if there are TVT environment related failures. If the failure related environment is indistinct, this kind of failure data shall not be included.

- d) Failure data from different lot tests. If the failure data are collected from different lots or replicating manufactured hardware, the failure data should be carefully analysed to determine if there are different number of failure cycles between lots or replicating hardware. Test parameters to influence the TESS, such as temperature range, temperature transition rate, hardware operation, failure modes, should be carefully examined.
- e) Failure data from thermal cycle tests (TCT). Thermo-mechanical fatigue failures in TCT may be included in the failure database.

Typical failure data and initial defects of electronic units are shown in [Table B.1](#).

The collected failure data shall be sorted in ascending order by the cycle number  $x$  when the failure is discovered and their corresponding test temperature range  $\Delta T$ . If there are  $k$  failures, the failure data shall be sorted to,

$$x = (x_1, x_2, \dots, x_k) \tag{1}$$

$$\Delta T = (\Delta T_1, \Delta T_2, \dots, \Delta T_k) \tag{2}$$

where

$x_i$  is the cycle number when the failure is discovered;  $i$  is the index of  $i^{\text{th}}$  failure;

$\Delta T_i$  is the TVT temperature range corresponding to the  $i^{\text{th}}$  failure.

If there are different TVT temperature ranges, temperature effect shall be considered by normalizing equivalent fatigue with the low-cycle fatigue equivalence.<sup>[4]</sup> The equivalent temperature normalized cycle number  $x'$  shall be decided by [Formula \(3\)](#).

$$x' = (x'_1, x'_2, \dots, x'_k) = (x_1 (\Delta T_1 / \Delta T')^b, x_2 (\Delta T_2 / \Delta T')^b, \dots, x_k (\Delta T_k / \Delta T')^b) \tag{3}$$

where

$b$  is the low-cycle fatigue equivalent exponent value;

$\Delta T'$  is the reference test temperature range in the TVT for equivalent temperature normalization; the minimum reference temperature for normalization shall be 55 °C.

Fatigue equivalent exponent  $b$  shall be determined by the material and failure mode of the test hardware.  $b = 2$  is recommended for solder joint, which is widely used for electric unit.<sup>[5]</sup> Empirically equivalent value comprising multiple failure modes, and materials should be calculated following the method in [4.4](#).

NOTE Examples of electric unit failure data related to manufacturing, material and workmanship defects, and cycle number that the failure occurred, normalized cycles number at reference temperature 85 °C using  $b = 2$ , are shown in [Table B.2](#).

### 4.3 Method 1 – Precipitation efficiency method

#### 4.3.1 General

The PE method is used to calculate probability of screening latent defects versus the number of cycles with the collected TVT failure database specified in [4.2](#). PE value calculated by this method shall be used to demonstrate the compliance with the relevant precipitation requirement designated by the customer and support the justification for execution of the option to reduce or a tailoring method to the baseline of thermal vacuum. PE value should be set to 0,95 for the acceptance thermal test<sup>[6]</sup>.